

Features

- Plastic package has UL Flammability Classification 94V-0
- Glass passivated chip junction
- High current capability
- Low forward voltage drop
- Dielectric tested to maximum case, storage and junction temperature to 150 °C to withstand 1500 V
- High temperature soldering guaranteed:275°C/10S
- Component in accordance to RoHS 2015/863/EU

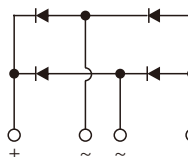
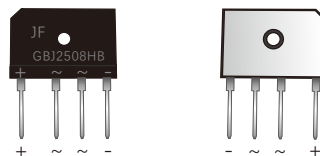
Mechanical data

- Case:GBJ-HB molded plastic body
- Terminals:Plated leads solderable per MIL-STD-750,method 2026
- Polarity:As marked
- Mounting Position:Any
- Mounting Torque:MAX 10cm-Kg(8.8inches-lbs)
- Recommended Torque: 5.7 cm-kg (5 inches-lbs)
- Weight:7.40grams(approx.)

Typical Applications

- Used in AC/DC bridge full wave rectificationfor SPS, home appliances and white-goods applications.

GBJHB



PRIMARY CHARACTERISTICS	
$I_F(AV)$	25A
V_{RRM}	600V,800V,1000V
I_{FSM}	300A
V_F at $I_F=12.5A$	1V
I_R	10 μ A
$T_J(MAX)$	150°C
Package	GBJHB

Maximum Ratings And Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave ,resistive or inductive load. For capacitive load,derate by 20%.)

Parameters	Symbol	GBJ2506HB	GBJ2508HB	GBJ2510HB	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	800	1000	V
Maximum average forward rectified current	$I_F(AV)$	25			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method,Total device)	I_{FSM}	300			A
Rating for fusing($t<8.3ms$)	I^2t	373.5			A ² S
Operating junction temperature range	T_J	-55 to 150			°C
Storge temperature range	T_{stg}	-55 to 150			°C

RATINGS AND CHARACTERISTICS OF GBJ2506HB THRU GBJ2510HB

Electrical Characteristcs (Per diode,T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	Typ.	Max.	Unit
Instaneous forward voltage	T _J =25°C	I _F =1A	V _F ¹⁾	0.81	-	V
		I _F =5A		0.90	-	
		I _F =12.5A		0.98	1.10	
	T _J =125°C	I _F =1A		0.66	-	
		I _F =5A		0.77	-	
	I _F =12.5A	0.87	-			
Reverse current	V _R =V _{RRM}	T _J =25°C	I _R ²⁾	-	5	µA
		T _J =100°C		-	70	
		T _J =125°C		-	250	
	Typical junction capacitance	4V,1MHz		C _J	100	

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle
2.Pulse test: pulse width≤40ms

Thermal Characteristics

Parameter	Symbol	GBJ	Unit
Typical thermal resistance ³⁾	R _{θJC}	1.0	°C/W

3.Thermal resistance from per diode junction to case

RATINGS AND CHARACTERISTICS OF GBJ2506HB THRU GBJ2510HB

Fig.1-Forward Current Derating Curve

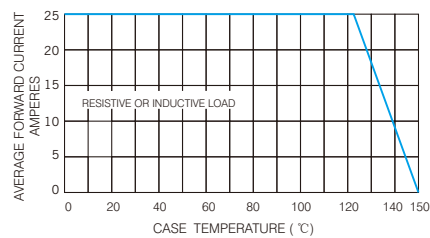


Fig.2-Maximum Non-repetitive Peak Forward Surge Current

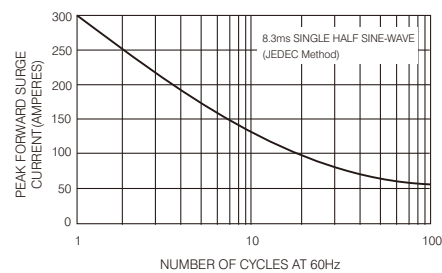


Fig.3-Typical Instantaneous Forward Characteristics

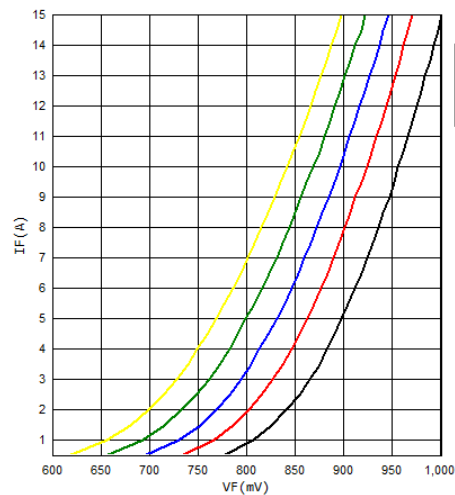


Fig.4-Typical Reverse Characteristics

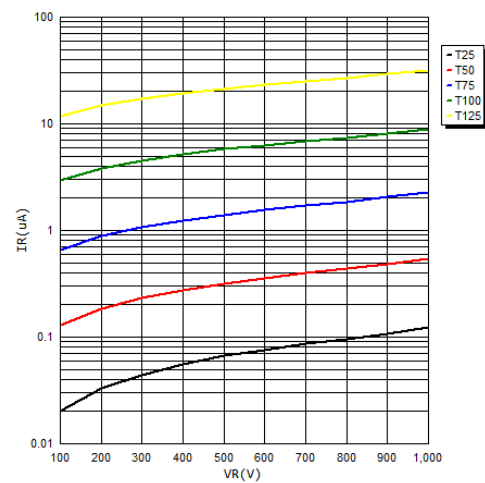
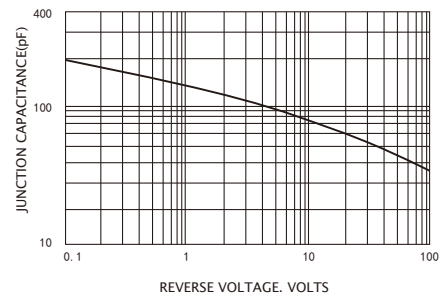
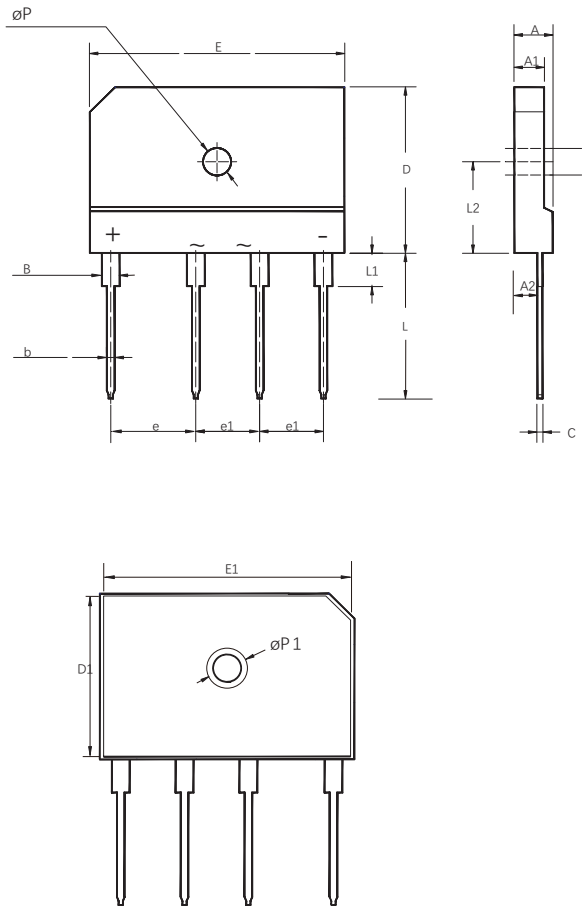


Fig.5-Typical Junction Capacitance



PACKAGE OUTLINE DIMENSIONS

GBJHB



GBJ		
Dim	Min	Max
A	4.40	5.00
A1	3.30	3.80
A2	2.60	3.00
B	1.90	2.40
b	0.90	1.10
C	0.60	0.80
D	19.60	20.60
D1	18.50	19.50
E	29.00	31.00
E1	28.50	29.50
e	9.50	10.50
e1	7.00	8.00
L	16.60	18.00
L1	3.00	4.20
L2	10.80	11.80
ϕP	3.10	3.80
$\phi P1$	5.10	5.90

Dimensions in millimeters

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